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Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China







CLB1108

Multi-phase power inductors



Product description

- High current multi-phase inductor
- 50nH per phase coupled inductor
- · Ferrite core material
- · Patents pending
- · Halogen free, lead free and RoHS compliant

Applications

 For exclusive use with Volterra® or Maxim® VPR-Devices

Environmental Data

- Storage temperature range (component): -40°C to +125°C
- Operating temperature range: -40°C to +125°C (ambient plus self-temperature rise)
- Solder reflow temperature: J-STD-020D compliant







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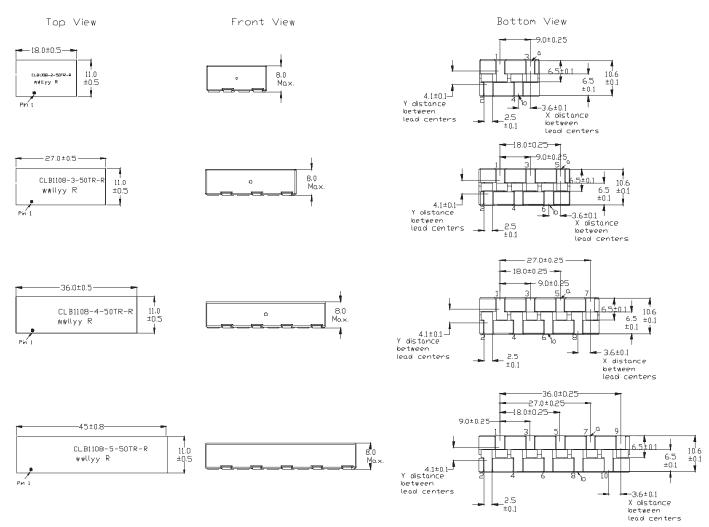
Product Specifications

Part Number ^{4,5}	Inductor phases	OCL min¹@ 0.0ADC (nH)	OCL min¹@ lsat1	lsat1² (amps)	OCL min ^{1A} @ Isat2	lsat2² (amps)	SCL³ (nH)	Isat3² (amps)	±10% (mΩ) @20°C
CLB1108-2-50TR-R	2	200	150	25	100	23	50	110	0.28
CLB1108-3-50TR-R	3	200	150	25	100	23	50	110	0.28
CLB1108-4-50TR-R	4	200	150	25	100	23	50	110	0.28
CLB1108-5-50TR-R	5	200	150	25	100	23	50	110	0.28

- 1. Open Circuit Inductance (OCL) Test Parameters: 1MHz, 0.1Vrms, @ 25°C
- 1A. Open Circuit Inductance (OCL) Test Parameters: 1MHz, 0.1Vrms, @ 105°C
- Isat1: Peak current at which OCL drops to 150nH min @ 25°C Isat2: Peak current at which OCL drops to 100nH min @ 105°C Isat3: Peak current where SCL drops approximately 20% @ 105°C
- 3. Short Circuit Inductance (SCL) Test Parameters: 1MHz, 0.1Vrms, 0.0Adc @ 25°C, ±20%
 - CLB1108-2-50TR-R, short 1 & 4, Measure 2 & 3 and divide by 2.
 - CLB1108-3-50TR-R, short 1 & 4, 3 & 6, Measure 2 & 5 and divide by 3
 - CLB1108-4-50-TR-R, short 1 & 4, 3 & 6, 5 & 8, Measure 2 & 7, and divide by 4
 - CLB1108-5-50-TR-R, short 1 & 4, 3 & 6, 5 & 8, 7 & 10, Measure 2 & 9 and divide by 5

- 4. Part Number Definition: CLB1108-X-50TR-R
 - CLB1108 = Product code and size
 - X = Number of phases
 - 50 = Inductance value per phase nH
 - TR = Tape and reel packaging
 - -R (suffix) = RoHS compliant
- 5. This device is licensed for use only when incorporated within a voltage regulator employing power regulating devices manufactured by Volterra Semiconductor, LLC or Maxim Integrated Devices, Inc. No license is granted expressly or by implication to use this device with power regulating devices manufactured by any company other than Volterra or Maxim.

Dimensions (mm)



Part marking: Pin 1 dot, CLB1108= (product code and size), -2,-3,-4,-5, = (number of phases), -50= (inductance value per phase in nH), TR= (tape and reel), -R = (RoHS compliant)

wwllyy = date code, R = revision level

Tolerances are ±0.25 millimeters unless stated otherwise

All soldering surfaces to be coplanar within 0.13 millimeter

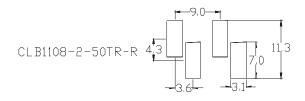
Do not route traces or vias underneath the inductor

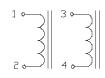
Pad layouts & schematics (mm)

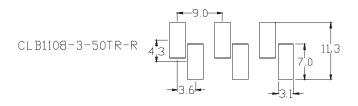
Tolerances are \pm 0.1 millimeters unless stated otherwise.

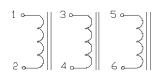
Recommended Pad Layout

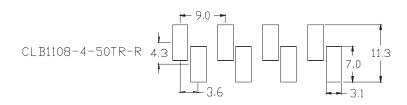
Schematic

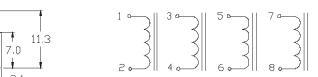


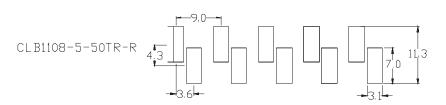


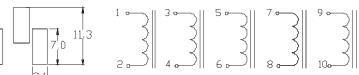






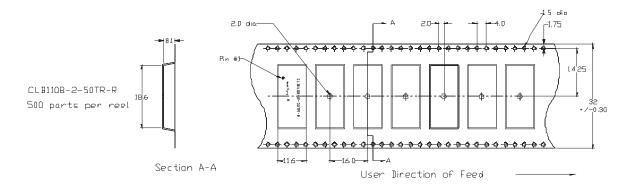


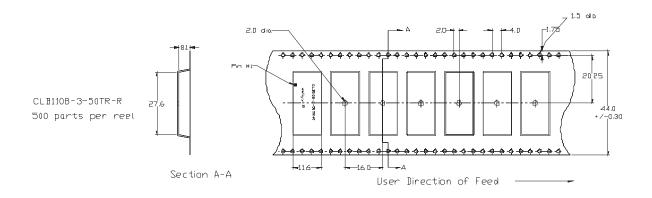


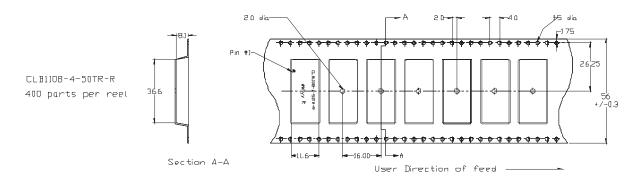


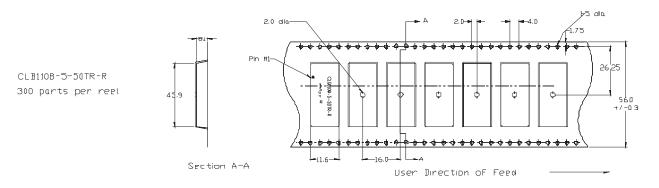
Packaging Information (mm)

Supplied in tape and reel packaging on a 13" diameter reel.

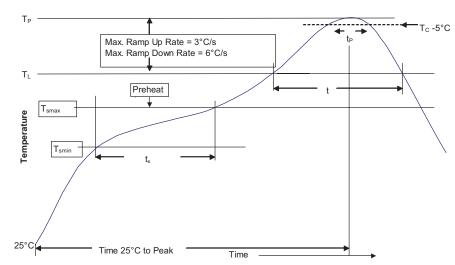








Solder reflow profile



 $-_{\mathsf{T_C}}$ -5°C Table 1 - Standard SnPb Solder ($\mathsf{T_C}$)

Package Thickness	Volume mm3 <350	Volume mm3 ≥350
<2.5mm)	235°C	220°C
≥2.5mm	220°C	220°C

Table 2 - Lead (Pb) Free Solder (T_C)

Package Thickness	Volume mm³ <350	Volume mm³ 350 - 2000	Volume mm³ >2000
<1.6mm	260°C	260°C	260°C
1.6 – 2.5mm	260°C	250°C	245°C
>2.5mm	250°C	245°C	245°C

Reference JDEC J-STD-020D

Profile Feature	Standard SnPb Solder	Lead (Pb) Free Solder	
Preheat and Soak • Temperature min. (T _{smin})	100°C	150°C	
• Temperature max. (T _{smax})	150°C	200°C	
• Time (T _{smin} to T _{smax}) (t _s)	60-120 Seconds	60-120 Seconds	
Average ramp up rate T _{smax} to T _p	3°C/ Second Max.	3°C/ Second Max.	
Liquidous temperature (TL) Time at liquidous (tL)	183°C 60-150 Seconds	217°C 60-150 Seconds	
Peak package body temperature (Tp)*	Table 1	Table 2	
Time (t _p)** within 5 °C of the specified classification temperature (T _C)	20 Seconds**	30 Seconds**	
Average ramp-down rate (T _p to T _{smax})	6°C/ Second Max.	6°C/ Second Max.	
Time 25°C to Peak Temperature	6 Minutes Max.	8 Minutes Max.	

^{*} Tolerance for peak profile temperature (Tp) is defined as a supplier minimum and a user maximum.

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Eaton Electronics Division 1000 Eaton Boulevard Cleveland, OH 44122 United States www.eaton.com/elx

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Printed in USA
Publication No. 10131 BU-SB13117
December 2015



^{**} Tolerance for time at peak profile temperature (t_p) is defined as a supplier minimum and a user maximum.